



103262970 PATENT AND TRADEMARK OFFICE

Applicants	Kuk Yeong Yun, <i>et al.</i>
Application No Pending	Filing Date: June <u>/</u> , 2006
Title of Application:	Radiator For A Graphics Card Chipset

Mail Stop Assignment Recordation Services Director, U.S. Patent and Trademark Office Post Office Box 1450 Alexandria, VA 22313-1450

Patent Assignment Recordation Form Cover Sheet

Dear Sir:

II.

Please record the attached original document.

- 1. <u>Name of conveying parties</u>. Kuk Yeong Yun, Min Whan Seo, and Sang II Park.
- 2. <u>Name and Address of Receiving Party</u>. Zalman Tech Co., Ltd.; 1007, Daeryung Techno Town III; 448 Gasan-dong, Gumchun-gu; Seoul, Republic of Korea.
- 3. <u>Nature of Conveyance</u>: Assignment. <u>Execution Date</u>: April 24, 2006.
- 4. <u>Name and Address of Party to Whom Correspondence Concerning Document</u> <u>should be mailed</u>.

Wesley W. Whitmyer, Jr., Registration No. 33,558 Attorney for Applicants ST.ONGE STEWARD JOHNSTON & REENS LLC 986 Bedford Street Stamford, CT 06905-5619 203 324-6155

06/19/2006 CNEGA1 00000120 29261496 04 FC:8021 40.

- 40.00 OP
- 5. <u>Application Number</u>: This document is being filed together with a new application, which is also filed herewith.
- 6. <u>Total Number of Applications Involved</u>: 1.
- 7. <u>Total Fee (37 CFR 3.41)</u>. \$40.00 due. This amount has been added to the Application fee which is enclosed.

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Page 2 Assignment Kuk Yeong Yun, et al.

- 8. <u>Authorization to Charge Deposit Account</u>. The Commissioner is hereby authorized to charge any additional fees due by this paper and during the entire pendency of this Application to Account No. 19-4516.
- 9. <u>Statement and Signature</u>. Total number of pages including cover sheet, attachments and document are 5. To the best of my knowledge and belief, the foregoing information is true and correct and any copy submitted herewith is a true copy of the original document.

Respectfully submitted,

June 15, 2006

J. Park

Wesley W. Whitmyer, Jr., Registration No. 33,558 Hyun Jong Park, Limited Recognition No. L0076 Attorneys for Applicants ST.ONGE STEWARD JOHNSTON & REENS LLC 986 Bedford Street Stamford, CT 06905-5619 203 324-6155

Express Mail No. EL 889 896 509 US

<u>Assignment</u>

WHEREAS, We, the undersigned inventors, have made certain inventions or discoveries (or both) as set forth in an application for Letters Patent of the United States of America, entitled <u>A RADIATOR FOR A GRAPHICS CARD CHIPSET</u>,

bearing Patent Application Serial No._____, filed on

WHEREAS, ZALMAN TECH CO., LTD, organized and existing under the laws of <u>Rep. of Korea</u>, whose address is <u>1007, Daeryung Techno Town III, 448 Gasan-</u> dong, Gumchun-gu, Seoul, Republic of Korea,

and, together with its successors and assigns is hereinafter called "Assignee", and is desirous of acquiring the title, rights, benefits and privileges hereinafter recited;

NOW THEREFORE, for valuable consideration furnished by Assignee to us, receipt and sufficiency of which we hereby acknowledge, we hereby, without reservation:

1. Assign, transfer and convey to Assignee the entire right, title and interest in and to said inventions and discoveries, said application for Letters Patent of the United States of America, any and all other applications for Letters Patent on said inventions and discoveries in whatsoever countries, including all divisional, renewal, substitute, continuation and convention applications based in whole or in part upon said inventions or discoveries, or upon said applications, and any and all Letters Patent, reissues and extensions of Letters Patent granted for said inventions and discoveries or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said discoveries, said applications and said Letters Patent;

2. Authorize Assignee to file patent applications in any or all countries on any or all of said inventions and discoveries in our names or in the name of Assignee or otherwise as Assignee may deem advisable, under the International Convention or otherwise;

3. Authorize and request the Commissioner of Patents of the United States of America and the empowered officials of all other governments to issue or transfer all said Letters Patents to Assignee, as assignee of the entire right, title and interest therein or otherwise as Assignee may direct;

4. Warrant that we have not knowingly conveyed to others any right in said inventions, discoveries, applications or patents or any license to use the same or to make, use or sell anything embodying or utilizing any of said inventions or discoveries; and that we have good right to assign the same to Assignee without encumbrance;

5. Bind our heirs, legal representatives and assigns, as well as ourselves, to do, upon Assignee's request and at Assignee's expense, but without additional consideration to us or them, all acts reasonably serving to assure that said inventions and discoveries, said patent applications and said Letters Patent shall be held and enjoyed by Assignee as fully and entirely as the same could have been held and enjoyed by us, our heirs, legal representatives and assigns if this assignment had not been made; and particularly to execute and deliver to Assignee all lawful application documents, including petitions, specifications, and oaths, and all assignments, disclaimers, and lawful affidavits in form and substance as may be requested by Assignee; to communicate to Assignee all facts known to us relating to said inventions and discoveries or the history thereof; and to furnish Assignee with any and all documents, photographs, models, samples and other physical exhibits in our control or in the control of our heirs, legal representatives or assigns, which may be useful for establishing the facts of our conceptions, disclosures, and reduction to practice of said inventions and discoveries.

IN WITNESS WHEREOF, we the inventors, <u>YUN, Kuk Yeong</u>, <u>SEO, Min</u> <u>Whan</u> and <u>PARK, Sang II</u>, have hereunto duly executed this Assignment.

Signature of First Inventor

<u>YUN, Kuk Yeong</u> Full Name of First Inventor 24 April 2006

Date

Declaration of Witness for First Inventor

I declare that I was personally present and did see , who is personally known to me to be the person named in this assignment, duly sign and execute the same.

Declared at Seoul, Rep. of Korea, on 24 April 2006

Krm. HyunTur Signature of Witness

KIM, Hyunjung Full Name of Witness

Signature of Second Inventor

SEO, Min Whan Full Name of Second Inventor 24 April 2006

Date

Declaration of Witness for Second Inventor

I declare that I was personally present and did see , who is personally known to me to be the person named in this assignment, duly sign and execute the same.

Declared at Seoul, Rep. of Korea, on 24 April 2006

Kan Hyumgung Signature of Witness

KIM, Hyunjung Full Name of Witness

Signature of Third Inventor

PARK, Sang II Full Name of Third Inventor 24 April 2006

Date

Declaration of Witness for Third Inventor

I declare that I was personally present and did see , who is personally known to me to be the person named in this assignment, duly sign and execute the same.

Declared at Seoul, Rep. of Korea, on 24 April 2006

Kin Hyundure Signature of Witness

<u>KIM, Hyunjung</u> Full Name of Witness

> PATENT REEL: 018005 FRAME: 0340

RECORDED: 06/15/2006